



ORIENT

Photo coupler

Product Data Sheet

Part Number: OR-3H4

Customer: _____

Date: _____

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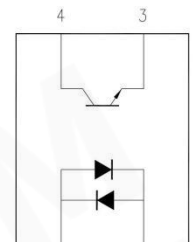
1. Features

- 1.Current transfer ratio(CTR) : MIN. 20% at $I_F = \pm 1\text{mA}$, $V_{CE} = 5\text{V}$, $T_a=25\text{ }^\circ\text{C}$
- 2.High input-output isolation voltage.($V_{ISO}=3,750\text{Vrms}$)
3. $BV_{CEO} = 80\text{V(MIN)}$
- 4.Operating temperature:-55 $^\circ\text{C}$ to 125 $^\circ\text{C}$
- 5.Lead free, in compliance with RoHS standards
- 6.MSL Class I



2. Instructions

The OR-3H4 series device contains two infrared led and a photo transistor detector. They are encapsulated in a 4-pin SOP, free of halogens and Sb2O3



1. Anode, Cathode 3. Emitter
2. Cathode, Anode 4. Collector

3. Application Range

- (1). Hybrid substrates that require high density mounting
- (2). Programmable controller
- (3). System apparatus, measuring instruments

4. Max Absolute rated Value (Normal Temperature=25 $^\circ\text{C}$)

Parameter		Symbol	Rated Value	Unit
Input	Forward Current	I_F	50	mA
	Peak forward current($t=10\mu\text{s}$)	I_{FM}	1	A
	Reverse Voltage	V_R	6	V
	Power Dissipation	P	65	mW
	Junction Temperature	T_j	125	$^\circ\text{C}$
Output	Collector and emitter Voltage	V_{CEO}	80	V
	Emitter and collector Voltage	V_{ECO}	7	
	Collector Current	I_C	50	mA
	Power Dissipation	P_C	150	mW
	Junction Temperature	T_j	125	$^\circ\text{C}$
Total Power Dissipation		P_{tot}	200	mW
*1 Insulation Voltage		V_{iso}	3750	Vrms
Operating Temperature		T_{opr}	-55 to +125	$^\circ\text{C}$
Storage Temperature		T_{stg}	-55 to +150	
*2 Soldering Temperature		T_{sol}	260	

*1. AC For 1 Minute, R.H. = 40 ~ 60%

Isolation voltage shall be measured using the following method.

(1) Short between anode and cathode on the primary side and between collector and emitter on the secondary side.

(2) The isolation voltage tester with zero-cross circuit shall be used.

(3) The waveform of applied voltage shall be a sine wave.

*2.soldering time is 10 seconds.

5. Opto-electronic Characteristics(Normal Temperature=25°C)

	Parameter	Symbol	Condition	Min	Typ.*	Max	Unit
Input	Forward Current	V_F	$I_F=\pm 20\text{mA}$	---	1.2	1.4	V
	Terminal Capacitance	C_t	$V=0, f=1\text{KHz}$	---	60	---	pF
Output	Collector Dark Current	I_{CEO}	$V_{CE}=20\text{V}, I_F=0\text{mA}$	---	---	100	nA
	Collector-Emitter Breakdown Voltage	BV_{CEO}	$I_C=0.1\text{mA}$ $I_F=0\text{mA}$	80	---	---	V
	Emitter-Collector Breakdown Voltage	BV_{ECO}	$I_E=0.1\text{mA}$ $I_F=0\text{mA}$	7	---	---	V
Transforming Characteristics	Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$I_F=\pm 8\text{mA}$ $I_C=2.4\text{mA}$	---	---	0.4	V
	Insulation Impedance	R_{iso}	DC500V 40~60%R.H.	5×10^{10}	1×10^{11}	---	Ω
	Floating Capacitance	C_f	$V=0, f=1\text{MHz}$	---	0.8	1	pF
	Response Time	t_r	$V_{CE}=10\text{V},$ $I_C=2\text{mA},$	---	3	18	μs
	Descend Time	t_f	$R_L=100\Omega,$ $f=100\text{Hz}$	---	4	18	μs

6. Order Information

Part Number

OR-3H4Y-Z

Note

Y = CTR Rank (A, A1, B, GR or none)

Z = Tape and reel option (TP or TP1).

* Halogen Free can be selected.

* VDE Code can be selected.

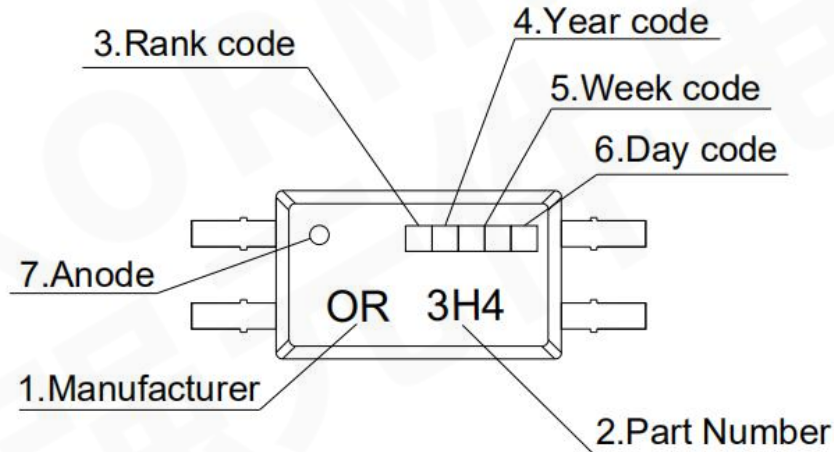
Option	Description	Packing quantity
TP	Surface mount lead form (low profile) + TP tape & reel option	3000 units per reel
TP1	Surface mount lead form (low profile) + TP1 tape & reel option	3000 units per reel

7. Rank table of current transfer ratio CTR

MODEL NO.	CTR Rank	Min.	Max.	Unit	Condition
<u>OR-3H4</u>	NO mark	20	400	%	IF=±1mA, V _{CE} =5V, Ta=25°C
	A	50	250		
	A1	100	200		
	B	100	400		
	GR	100	300		IF=±5mA, V _{CE} =5V, Ta=25°C

- Current Conversion Ratio = $I_C / I_F \times 100\%$

8. Naming Rule

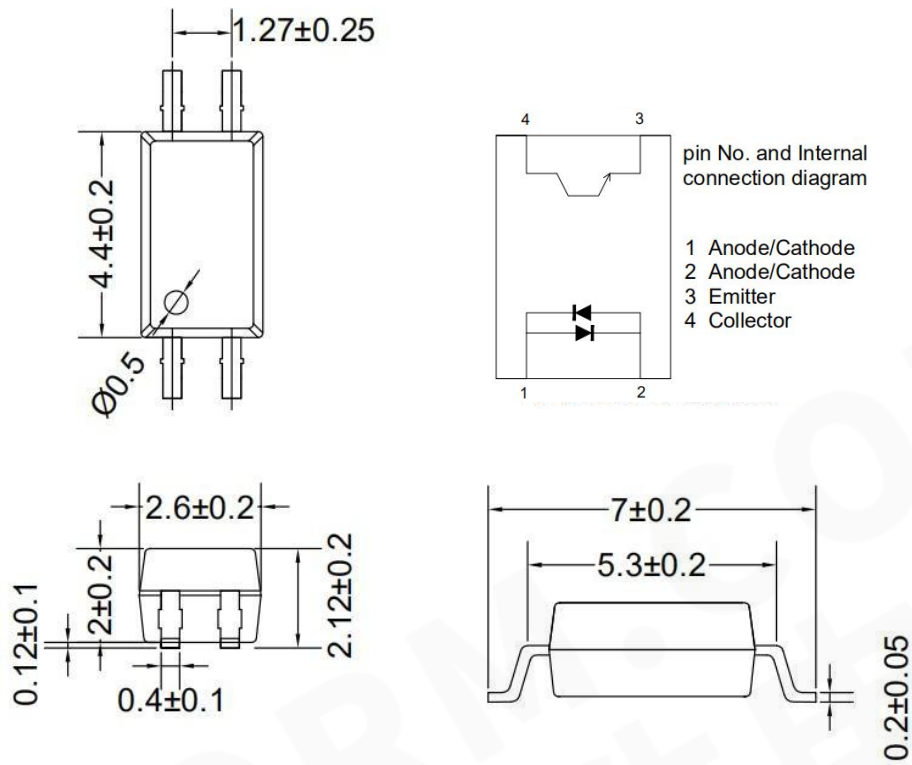


- (1) ORIENT.
- (2) 3H4 denotes Device Part Number.
- (3) denotes Rank Code.
- (4) denotes Year Code.
- (5) denotes Week Code.
- (6) denotes Day Code.
- (7) Anode.

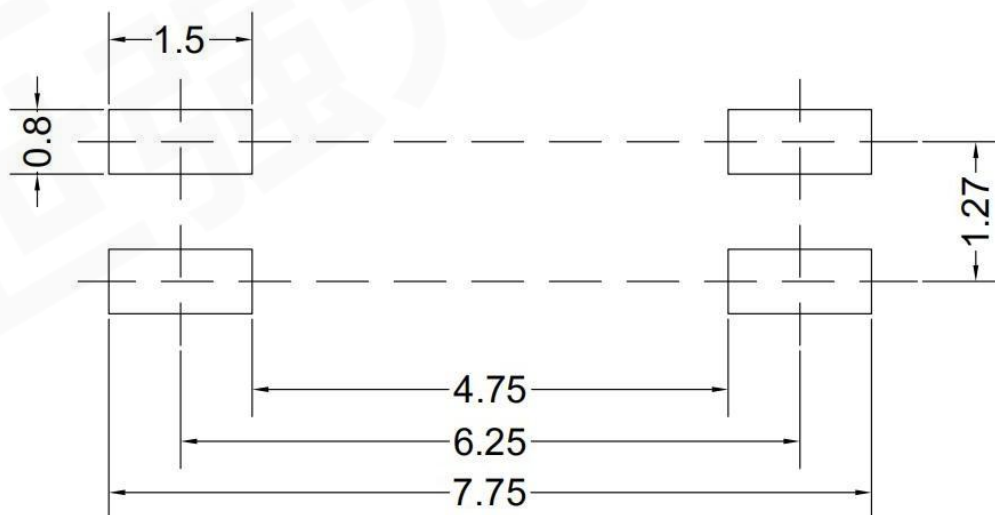
* If the photo coupler is Free from Halogen, there will be a ‘G’ mark in the upper left corner.

* VDE Code can be selected.

9. Outer Dimension

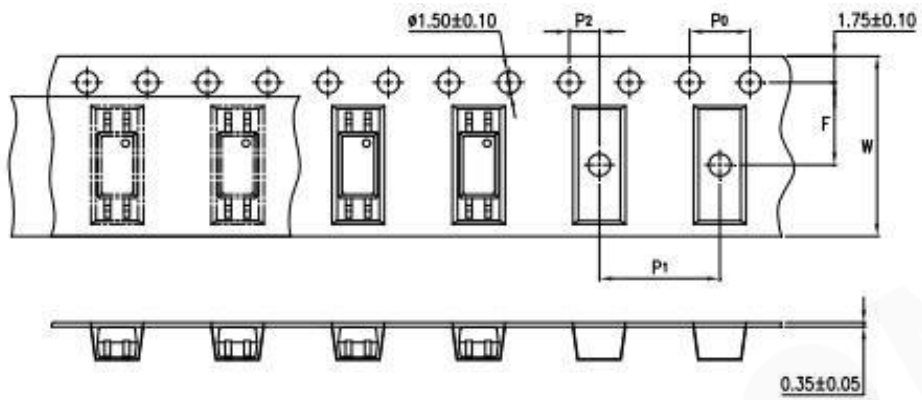


10. Recommended Foot Print Patterns (Mount Pad) (unit: mm)

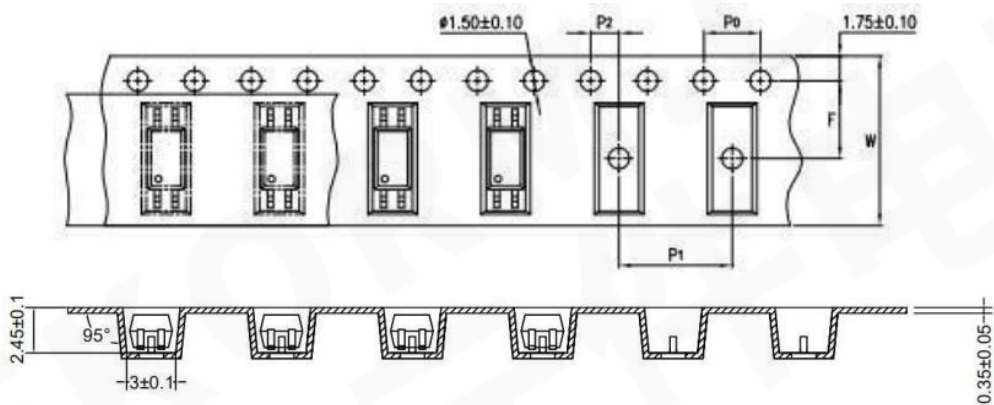


11. Taping Dimensions

(1) OR-3H4-TP



(2) OR-3H4-TP1



type	Symbol	Dimensions: mm (in.)
bandwidth	W	12±0.3 (0.47)
pitch	P0	4±0.1 (0.15)
pitch	F	5.5±0.1 (0.217)
	P2	2±0.1 (0.079)
interval	P1	8±0.1 (0.315)

Encapsulation type	<u>OR-3H4</u>
Quantity (pieces)	3000

12. Package Dimension

(1) package dimension

Packing Information

Packing Information	
Packing type	Reel type
Tape Width	12mm
Qty per Reel	3,000
Small box (inner) Dimension	345*345*45mm
Max qty per small box	6,000
Large box (Outer) Dimension	480x360x360mm
Max qty per large box	60,000

(2) Packing Label Sample



1. MTL NO:Contents with "Order Information" in the specification.
2. LOT NO:The production cycle of the product.
3. BATCH:The CTR RANK of the product.
4. Quantity:Product packaging quantity.
5. Product Data: The data when product be made.

13. Reliability Test

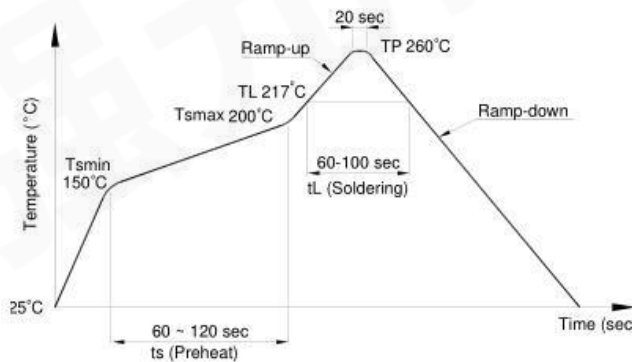
NO.	Item	Condition	Quantity	Cycle	Reference Standards
1	RSH, Resistance to Solder Heat	260±5°C, 10s/cycle	22	3cycles	JESC22A-106
2	SD, Solderability	260±5°C, 2-3s/cycle	22	1cycle	JESD22-B102
3	TC, Temperature Cycle	H: 125°C 15min ∫ 5min L: -55°C 15min	77	300cycles	JESC22A-104
4	TS, Thermal Shock	H:100°C 5min ∫ 15s L:-10°C 5min	77	300cycles	JESC22A-106
5	LTSL, Low Temperature Storage	T:-55°C	77	1000h	JESD22-A119
6	HTSL, High Temperature Storage	T:125°C	77	1000h	JESC22A-103
7	THB, High Temperature High Humidity	T:85°C RH: 85%	77	1000h	JESC22A-101
8	HTOL DC Operating Life	T: 110°C IF=10mA VCC=5V	77	1000h	MIL-STD-750 Method 1037
9	ESD-HBM Human Body Model ESD	Ta=25° C, Reference JESD22-A114	6	1cycle	JESD22-A114

14. Temperature Profile Of Soldering

(1) IR Reflow soldering (JEDEC-STD-020C compliant)

One time soldering reflow is recommended within the condition of temperature and time profile shown below. Do not solder more than three times.

Profile item	Conditions
Preheat	
- Temperature Min (T _{Smin})	150°C
- Temperature Max (T _{Smax})	200°C
- Time (min to max) (t _s)	90±30 sec
Soldering zone	
- Temperature (T _L)	217°C
- Time (t _L)	60~100 sec
Peak Temperature	260°C
Ramp-up rate	3°C / sec max.
3°C / sec max.	3~6°C / sec



(2) Hand soldering by soldering iron

Allow single lead soldering in every single process. One time soldering is recommended.

Temperature	380+0/-5°C
Time	3 sec max

15. Characteristics Curve

Figure 1. Collector Power Dissipation vs. Ambient Temperature

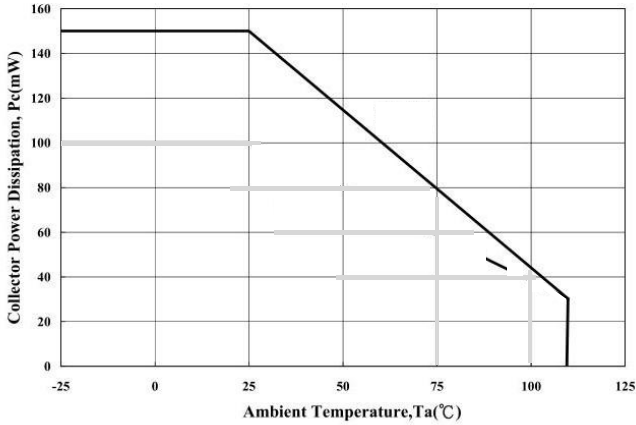


Figure 2. Forward Current vs. Ambient Temperature

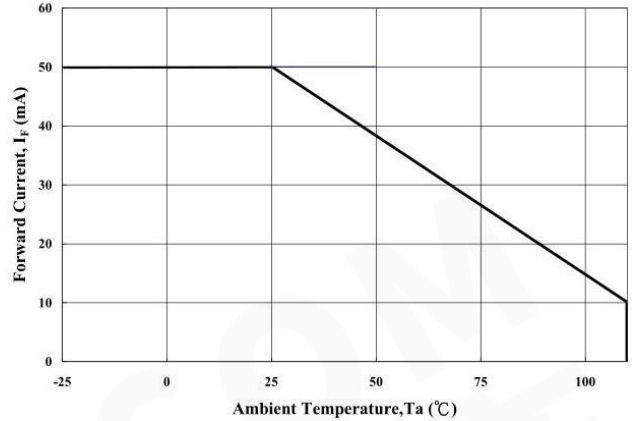


Figure 3. Forward Current vs. Forward Voltage

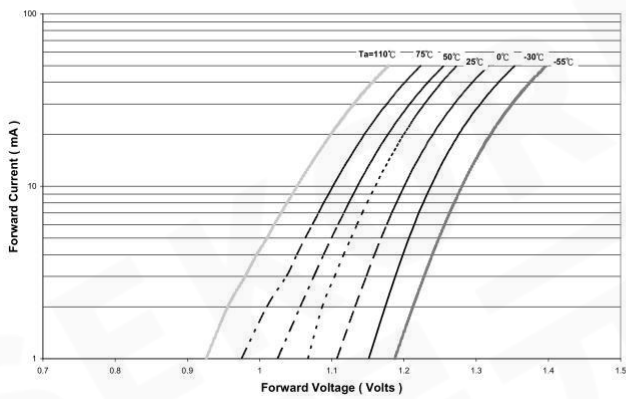


Figure 4. Forward Voltage Temperature Coefficient vs. Forward Current

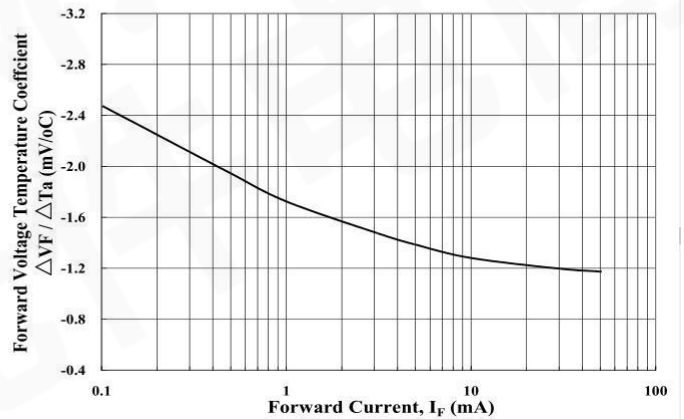


Figure 5. Pulse Forward Current vs. Duty Cycle Ratio

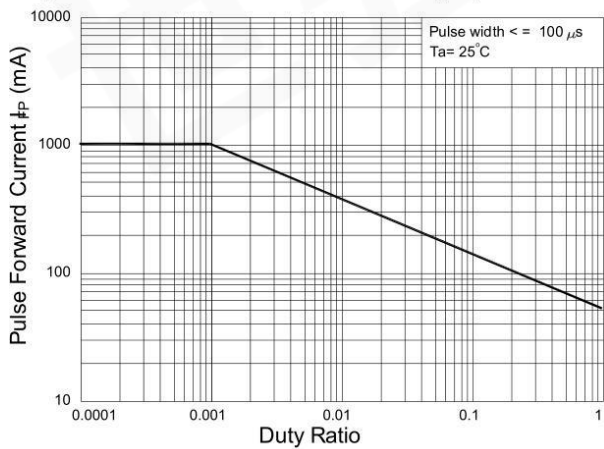


Figure 6. Pulse Forward Current vs. Pulse Forward Voltage

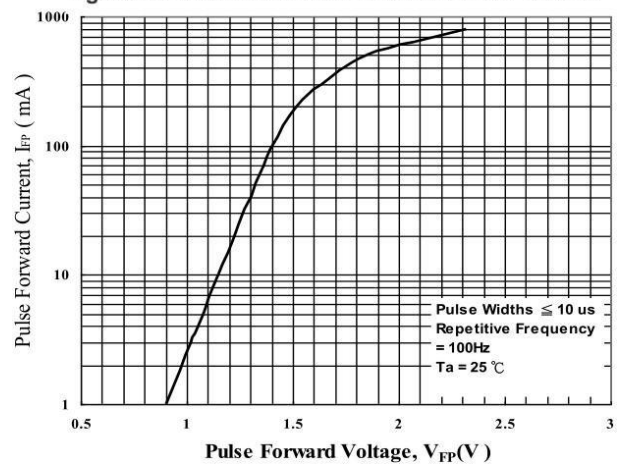


Figure 7. Collector-Emitter Saturation Voltage vs. Forward

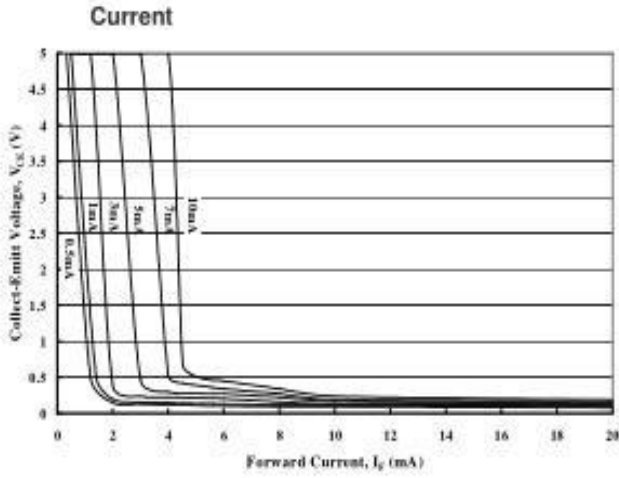


Figure 8. Collector Current vs. Collector-Emitter

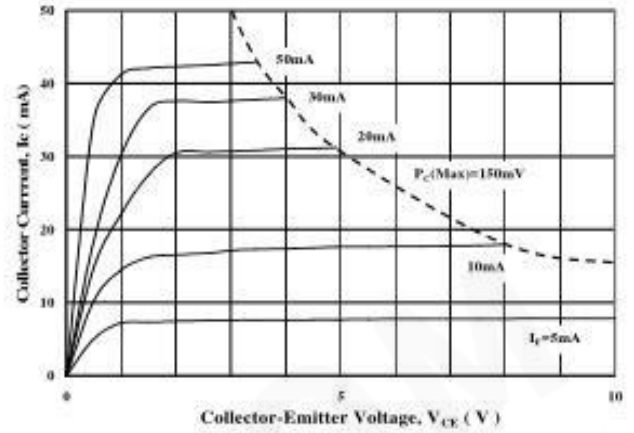


Figure 9. Collector Current vs. Small Collector-Emitter

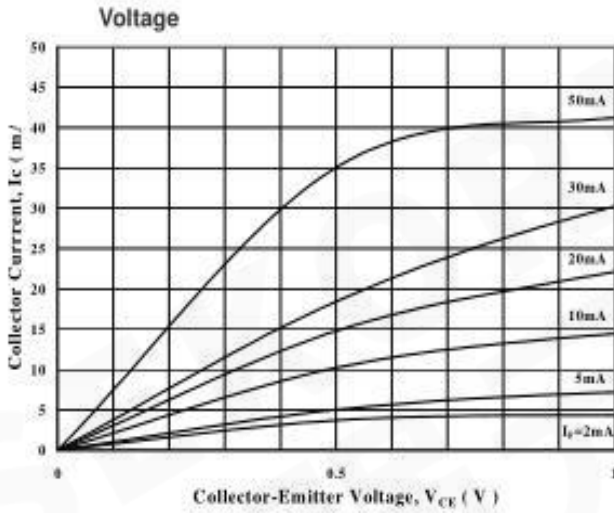


Figure 10. Normalized CTR vs. Forward Current

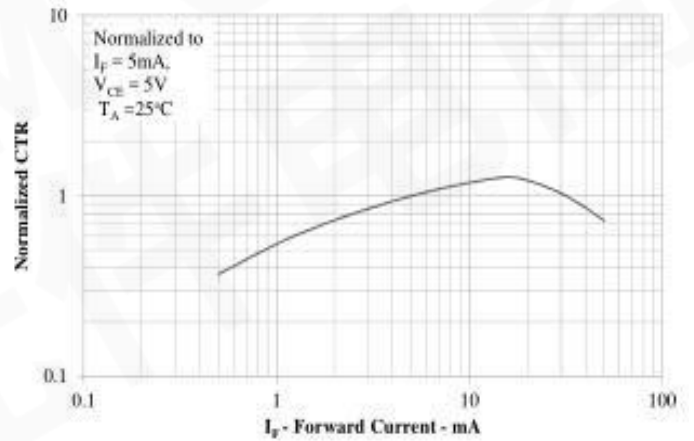


Figure 11. Collector Dark Current vs. Ambient Temperature

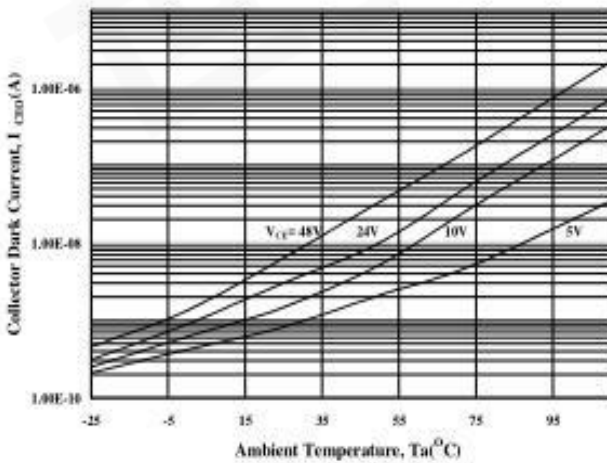


Figure 12. Current Transfer Ratio vs. Forward

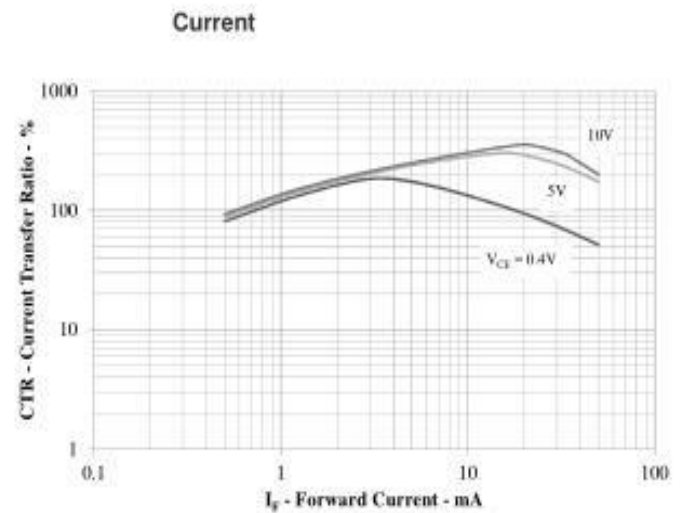


Figure 13. Normalized CTR vs. Ambient Temperature

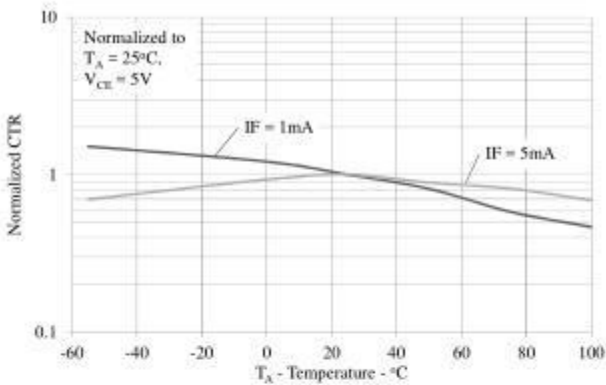


Figure 14. Collector-Emitter Saturation Voltage vs. Ambient Temperature

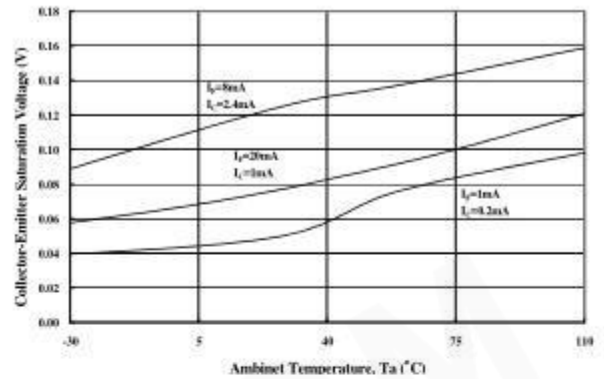


Figure 15. Collector Current vs. Ambient Temperature

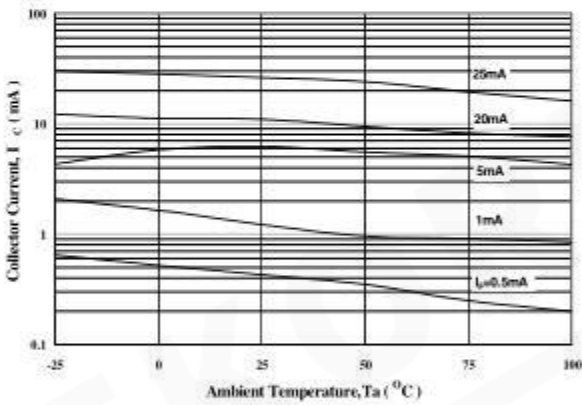


Figure 16. Switching Time vs. Load Resistance

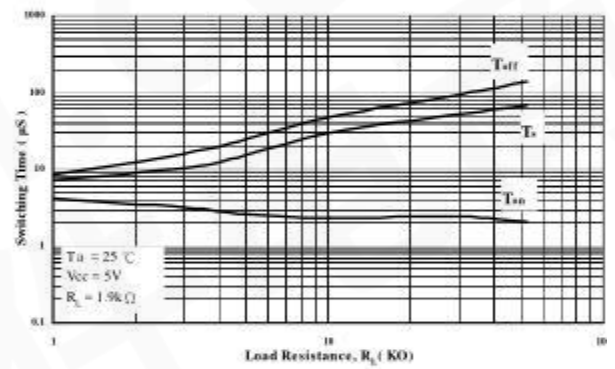


Figure 17. Switching Time vs. Ambient Temperature

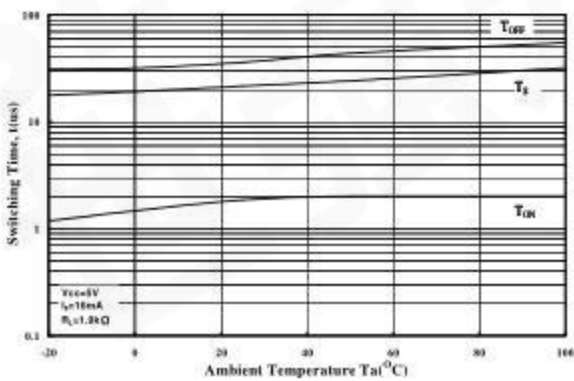
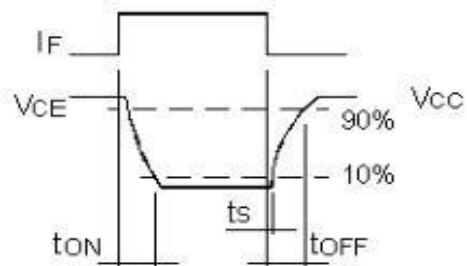
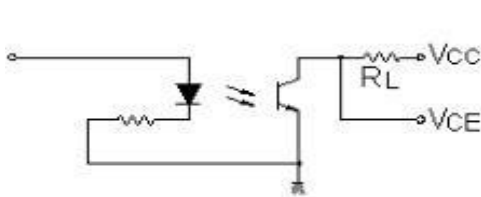
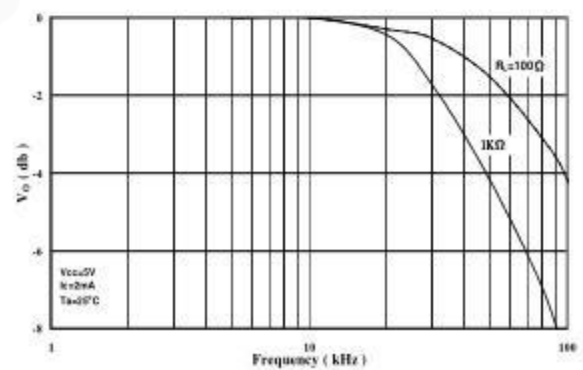


Figure 18. Frequency Response



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